SGM8252A 2.8MHz, High Voltage, High Precision, Low Noise Rail-to-Rail Output Operational Amplifier

GENERAL DESCRIPTION

The dual SGM8252A is a rail-to-rail output, low noise and high precision operational amplifier which has low input offset voltage and bias current. It is guaranteed to operate from 4.5V to 36V single supply.

The rail-to-rail output swing provided by the SGM8252A makes both high-side and low-side sensing easy. The combination of these characteristics makes the SGM8252A a good choice for temperature, position and pressure sensors, medical equipment and strain gauge amplifiers, or any other 4.5V to 36V applications requiring precision and long term stability.

The dual SGM8252A is available in Green SOIC-8 and MSOP-8 packages. It is rated over the -40°C to +125°C temperature range.

FEATURES

- Low Offset Voltage: 18µV (MAX)
- Rail-to-Rail Output Swing
- 4.5V to 36V Single Supply Operation
- Open-Loop Voltage Gain: 150dB (TYP)
- PSRR: 150dB (TYP)
- CMRR: 135dB (TYP)
- 0.1Hz to 10Hz Noise: 0.4µV_{P-P}
- Input Voltage Noise Density: 20nV/ $\sqrt{_{Hz}}~$ at 1kHz
- Gain-Bandwidth Product: 2.8MHz
- Low Supply Current: 450µA/Amplifier (TYP)
- Overload Recovery Time: 3µs
- -40°C to +125°C Operating Temperature Range
- Available in Green SOIC-8 and MSOP-8 Packages

APPLICATIONS

Temperature Measurements Pressure Sensors Precision Current Sensing Electronic Scales Strain Gauge Amplifiers Medical Instrumentation Thermocouple Amplifiers Handheld Test Equipment

SGM8252A

PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION	
SGM8252A	SOIC-8	-40°C to +125°C	SGM8252AXS8G/TR	SGM 8252AXS8 XXXXX	Tape and Reel, 4000	
	MSOP-8	-40°C to +125°C	SGM8252AXMS8G/TR	SGM8252A XMS8 XXXXX	Tape and Reel, 4000	

MARKING INFORMATION

NOTE: XXXXX = Date Code and Vendor Code.

SOIC-8/MSOP-8



Vendor Code

Date Code - Week

— Date Code - Year

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage	40V
Input Voltage Range (-V _S) - 0.3	/ to (+V _S) + 0.3V
Differential Input Voltage Range	5V to 5V
Junction Temperature	+150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (Soldering, 10s)	+260°C
ESD Susceptibility	
HBM	6000V
MM	300V
CDM	1000V

RECOMMENDED OPERATING CONDITIONS

Operating Voltage Range4.5V to 36V Operating Temperature Range40°C to +125°C Differential Input Voltage Range0.7V to 0.7V

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

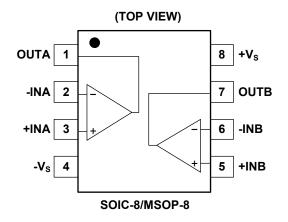
ESD SENSITIVITY CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATIONS



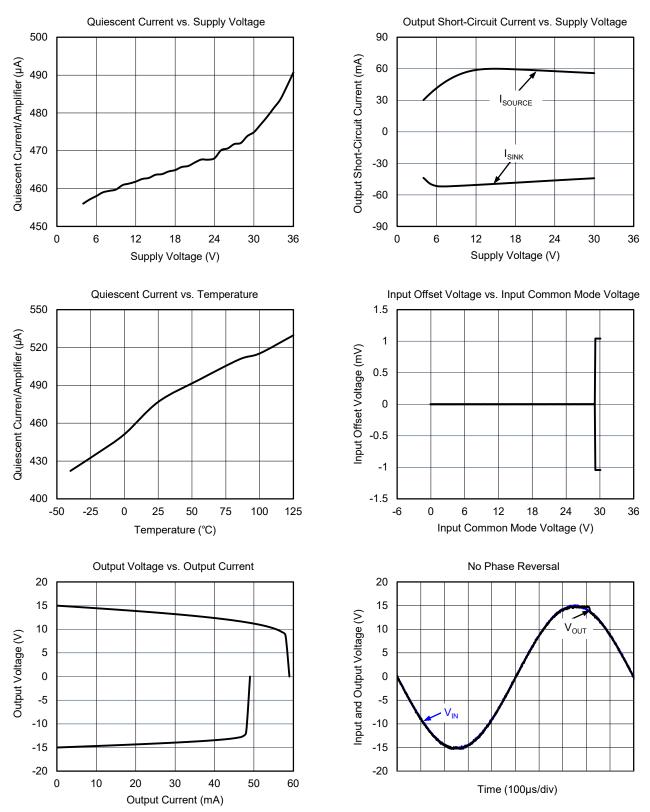
ELECTRICAL CHARACTERISTICS

(At $T_A = +25^{\circ}$ C, $V_S = \pm 2.5$ V to $V_S = \pm 18$ V, $V_{CM} = 0$ V and $R_L = 10k\Omega$ connected to 0V, Full = -40°C to +125°C, unless otherwise noted.)

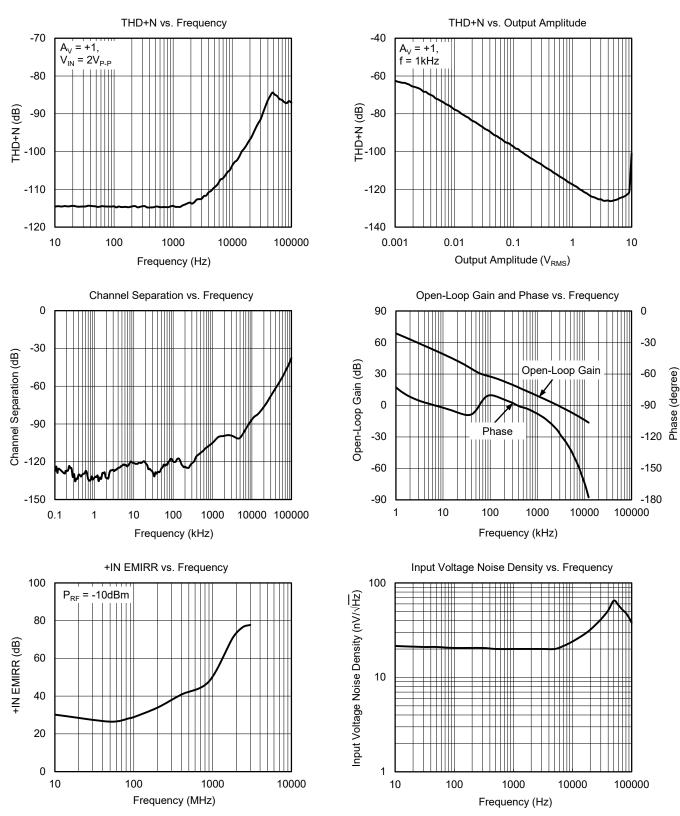
PARAMETER	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS	
Input Characteristics		I	1 1				
		+25°C		5	18	.,	
Input Offset Voltage (V _{OS})		Full			20	μV	
Input Offset Voltage Drift (ΔV _{os} /ΔT)		Full		20		nV/°C	
Input Bias Current (I _B)		+25°C		±100	±400	pА	
Input Offset Current (Ios)		+25°C		±200	±600	pА	
Input Common Mode Voltage Range (V _{CM})		Full	(-V _s) - 0.05		(+V _s) -1.5	V	
		+25°C	115	135			
Common Mode Rejection Ratio ⁽¹⁾ (CMRR)	$V_{CM} = (-V_S) - 0.05V$ to $(+V_S) - 1.5V$	Full	112			dB	
		+25°C	118	140			
	$V_{S} = \pm 2.5 V, V_{OUT} = \pm 2.0 V$	Full	115			1	
Open-Loop Voltage Gain (A _{OL})		+25°C	128	150		dB	
	$V_{S} = \pm 18V, V_{OUT} = \pm 17.5V$	Full	125				
Output Characteristics			<u> </u>				
		+25°C		12	25		
Output Voltage Swing from Rail	$V_{s} = \pm 2.5 V$	Full			30	- mV	
		+25°C		95	140		
	$V_{s} = \pm 18V$	Full			200		
		+25°C	±20	±32			
	$V_{\rm S} = \pm 2.5 V$	Full	±11			_	
Output Short-Circuit Current (I _{SC})		+25°C	±38	±50		mA	
	$V_{\rm S} = \pm 18V$	Full	±18			-	
Power Supply							
Operating Voltage Range (Vs)		Full	4.5		36	V	
		+25°C		450	660		
Quiescent Current/Amplifier (I _Q)	I _{OUT} = 0	Full			750	μA	
		+25°C	128	150			
Power Supply Rejection Ratio ⁽¹⁾ (PSRR)	V _s = 4.5V to 36V	Full	125			dB	
Dynamic Performance			-				
Gain-Bandwidth Product (GBP)	V _{OUT} = 100mV _{P-P} , C _L = 10pF	+25°C		2.8		MHz	
Slew Rate (SR)		+25°C		1.3		V/µs	
Settling Time to 0.1% (t _s)	V _{IN} = 1V Step, A _V = +1	+25°C		0.8		μs	
Overload Recovery Time	$V_{IN} \times A_V > V_S$	+25°C		3		μs	
Total Harmonic Distortion + Noise (THD+N)	$V_{IN} = 2V_{P-P}, A_V = +1, f = 1kHz$	+25°C		0.0002		۳0 %	
Noise		1200	1	0.0002	1	1 /0	
Input Voltage Noise	f = 0.1Hz to 10Hz	+25°C		0.4		μV _{P-P}	
	f = 0.1kHz	+25°C		20		P * P P	
Input Voltage Noise Density (eո)	f = 1kHz	+25°C		20		nV/√H	
input voltage ivolae Denaity (cn)							
	f = 10kHz	+25°C		23			

NOTE: 1. PSRR and CMRR are affected by the matching between external gain-setting resistor ratios.

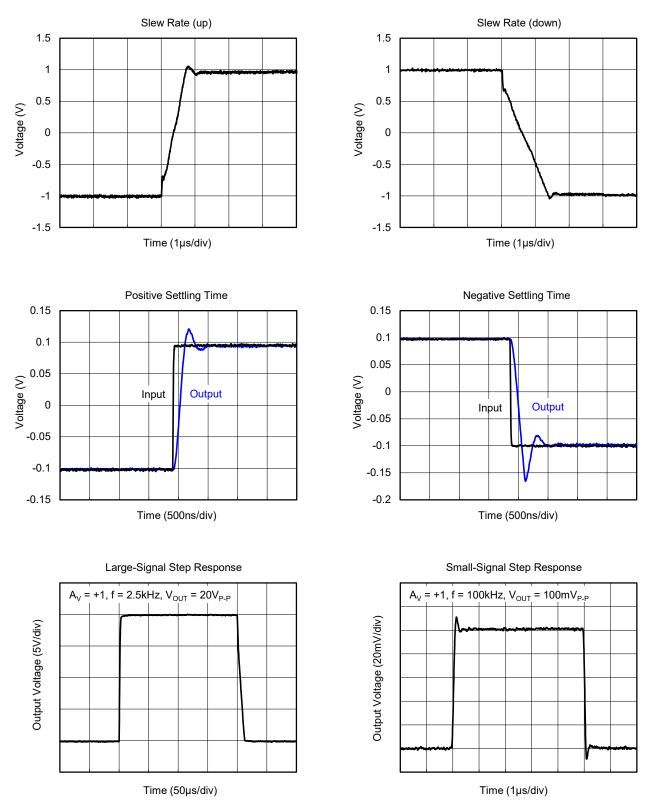
TYPICAL PERFORMANCE CHARACTERISTICS



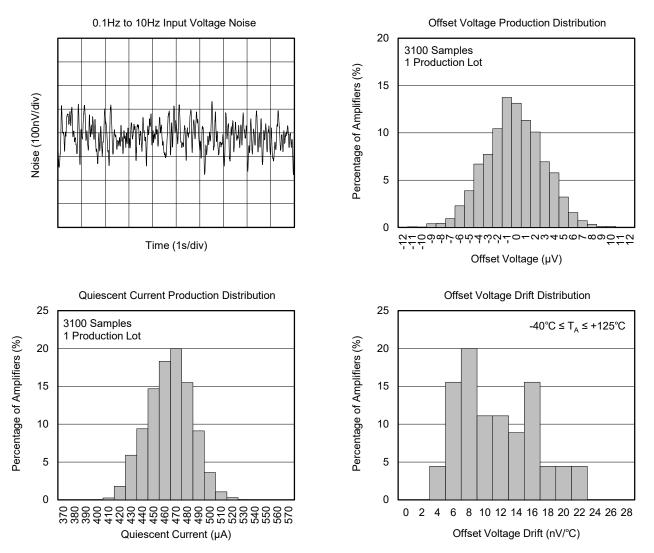
TYPICAL PERFORMANCE CHARACTERISTICS (continued)



TYPICAL PERFORMANCE CHARACTERISTICS (continued)



TYPICAL PERFORMANCE CHARACTERISTICS (continued)



APPLICATION NOTES

Driving Capacitive Loads

The unity-gain follower (buffer) is the most sensitive configuration to capacitive loading. Direct capacitive loading reduces the phase margin of amplifiers and this results in ringing or even oscillation. Applications that require greater capacitive driving capability should use an isolation resistor between the output and the capacitive load like the circuit in Figure 1. The isolation resistor R_{ISO} and the load capacitor C_L form a zero to increase stability. The bigger the R_{ISO} resistor value, the more stable V_{OUT} will be. Note that this method results in a loss of gain accuracy because R_{ISO} forms a voltage divider with the R_{LOAD}.

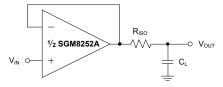


Figure 1. Indirectly Driving Heavy Capacitive Load

An improved circuit is shown in Figure 2. It provides DC accuracy as well as AC stability. R_F provides the DC accuracy by connecting the inverting input with the output. C_F and R_{ISO} serve to counteract the loss of phase margin by feeding the high frequency component of the output signal back to the amplifier's inverting input, thereby preserving phase margin in the overall feedback loop.

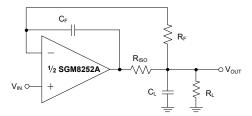


Figure 2. Indirectly Driving Heavy Capacitive Load with DC Accuracy

For non-buffer configuration, there are two other ways to increase the phase margin: (a) by increasing the amplifier's closed-loop gain or (b) by placing a capacitor in parallel with the feedback resistor to counteract the parasitic capacitance associated with inverting node.

Power Supply Bypassing and Layout

The SGM8252A operates from either a single 4.5V to 36V supply or dual $\pm 2.25V$ to $\pm 18V$ supplies. For

single-supply operation, bypass the power supply +V_S with a 0.1µF ceramic capacitor which should be placed close to the +V_S pin. For dual-supply operation, both the +V_S and the -V_S supplies should be bypassed to ground with separate 0.1µF ceramic capacitors. 2.2µF tantalum capacitor can be added for better performance.

Good PC board layout techniques optimize performance by decreasing the amount of stray capacitance at the operational amplifier's inputs and output. To decrease stray capacitance, minimize trace lengths and widths by placing external components as close to the device as possible. Use surface-mount components whenever possible.

For the operational amplifier, soldering the part to the board directly is strongly recommended. Try to keep the high frequency current loop area small to minimize the EMI (electromagnetic interference).

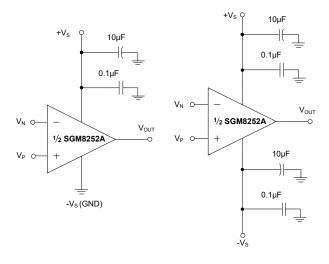


Figure 3. Amplifier with Bypass Capacitors

Grounding

A ground plane layer is important for SGM8252A circuit design. The length of the current path in an inductive ground return will create an unwanted voltage noise. Broad ground plane areas will reduce the parasitic inductance.

Input-to-Output Coupling

To minimize capacitive coupling, the input and output signal traces should not be in parallel. This helps reduce unwanted positive feedback.

SGM8252A

TYPICAL APPLICATION CIRCUITS

Differential Amplifier

The circuit shown in Figure 4 performs the difference function. If the resistor ratios are equal $(R_4/R_3 = R_2/R_1)$, then $V_{OUT} = (V_P - V_N) \times R_2/R_1 + V_{REF}$.

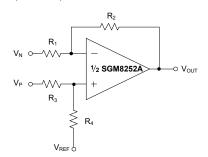


Figure 4. Differential Amplifier

Instrumentation Amplifier

The circuit in Figure 5 performs the same function as that in Figure 4 but with a high input impedance.

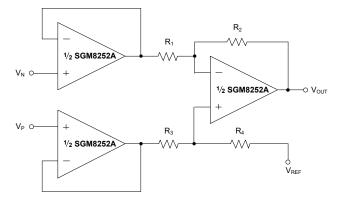


Figure 5. Instrumentation Amplifier

Active Low-Pass Filter

The low-pass filter shown in Figure 6 has a DC gain of $(-R_2/R_1)$ and the -3dB corner frequency is $1/2\pi R_2 C$. Make sure the filter bandwidth is within the bandwidth of the amplifier. Feedback resistors with large values can couple with parasitic capacitance and cause undesired effects such as ringing or oscillation in high-speed amplifiers. Keep resistor values as low as possible and consistent with output loading consideration.

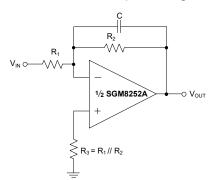
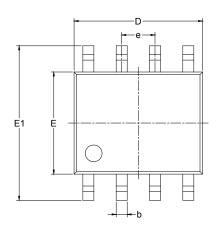
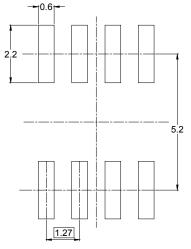


Figure 6. Active Low-Pass Filter

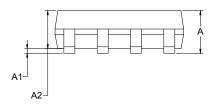
PACKAGE OUTLINE DIMENSIONS

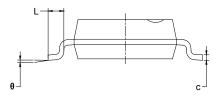
SOIC-8





RECOMMENDED LAND PATTERN (Unit: mm)

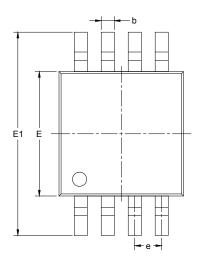


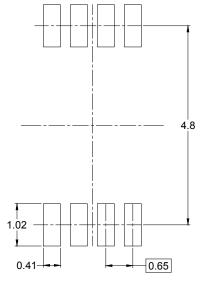


Symbol		nsions meters	Dimensions In Inches		
	MIN	MAX	MIN	MAX	
A	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.27 BSC		0.050	BSC	
L	0.400	1.270	0.016	0.050	
θ	0° 8°		0°	8°	

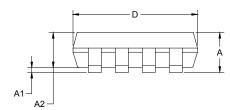
PACKAGE OUTLINE DIMENSIONS

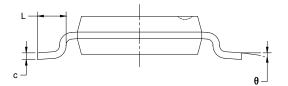
MSOP-8





RECOMMENDED LAND PATTERN (Unit: mm)

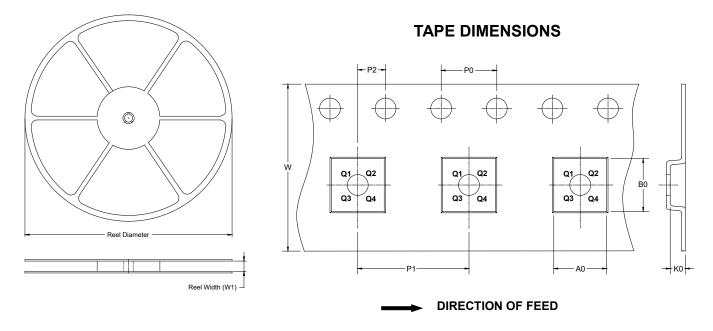




Symbol		nsions meters	Dimensions In Inches		
	MIN	MAX	MIN	MAX	
A	0.820	1.100	0.032	0.043	
A1	0.020	0.150	0.001	0.006	
A2	0.750	0.950	0.030	0.037	
b	0.250	0.380	0.010	0.015	
С	0.090	0.230	0.004	0.009	
D	2.900	3.100	0.114	0.122	
E	2.900	3.100	0.114	0.122	
E1	4.750	5.050	0.187	0.199	
е	0.650 BSC		0.026	BSC	
L	0.400	0.800	0.016	0.031	
θ	0°	6°	0°	6°	

TAPE AND REEL INFORMATION

REEL DIMENSIONS

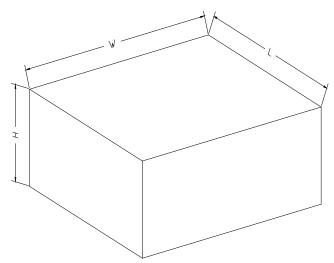


NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOIC-8	13″	12.4	6.40	5.40	2.10	4.0	8.0	2.0	12.0	Q1
MSOP-8	13″	12.4	5.20	3.30	1.50	4.0	8.0	2.0	12.0	Q1

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton	
13″	386	280	370	5	DD0002